

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I declare that:

My residence, post office address and citizenship are as stated below next to my name; I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **RUBBER PLATE USED IN AN ION IMPLANTER AND METHOD OF PREPARING THE SAME** the specification of which X is attached hereto or was filed on as Application No. and was amended on (if applicable).

I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56. I claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

Country	Application No.	Date of Filing	Priority Claimed Under 35 USC 119
Taiwan, R.O.C.	90105018	03/05/01	

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Chun-Pok Leung, Reg. No. 41,405
Henry K. Woodward, Reg. No. 22,672
Richard T. Ogawa, Reg. No. 37,692

Send Correspondence to: Chun-Pok Leung TOWNSEND and TOWNSEND and CREW LLP Two Embarcadero Center, 8th Floor San Francisco, California 94111-3834	Direct Telephone Calls to: (Name, Reg. No., Telephone No.) Name: Chun-Pok Leung Reg. No.: 41,405 Telephone: 650-326-2400
---	--

Full Name of Inventor 1:	Last Name: PAN	First Name: CHENG-MIN	Middle Name or Initial:	
Residence & Citizenship:	City: Hsinchu	State/Foreign Country: Taiwan, R.O.C.	Country of Citizenship: Taiwan	
Post Office Address:	Post Office Address: No. 19, Li Hsin Road Science-Based Industrial Park	City: Hsinchu	State/Country: Taiwan, R.O.C.	Postal Code:
Full Name of Inventor 2:	Last Name: TSENG	First Name: HUA-JEN	Middle Name or Initial:	
Residence & Citizenship:	City: Hsinchu	State/Foreign Country: Taiwan, R.O.C.	Country of Citizenship: Taiwan	
Post Office Address:	Post Office Address: No. 19, Li Hsin Road Science-Based Industrial Park	City: Hsinchu	State/Country: Taiwan, R.O.C.	Postal Code:

Full Name of Inventor 3:	Last Name: LEE	First Name: CHUN-CHIEH	Middle Name or Initial:	
Residence & Citizenship:	City: Hsinchu	State/Foreign Country: Taiwan, R.O.C.	Country of Citizenship: Taiwan	
Post Office Address:	Post Office Address: No. 19, Li Hsin Road Science-Based Industrial Park	City: Hsinchu	State/Country: Taiwan, R.O.C.	Postal Code:
Full Name of Inventor 4:	Last Name: HUNG	First Name: SHENG-FENG	Middle Name or Initial:	
Residence & Citizenship:	City: Hsinchu	State/Foreign Country: Taiwan, R.O.C.	Country of Citizenship: Taiwan	
Post Office Address:	Post Office Address: No. 19, Li Hsin Road Science-Based Industrial Park	City: Hsinchu	State/Country: Taiwan, R.O.C.	Postal Code:

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Signature of Inventor 1 <u>Cheng-Min Pan</u> Cheng-Min Pan Date <u>01/22/02</u>	Signature of Inventor 2 <u>Hua-Jen Tseng</u> Hua-Jen Tseng Date <u>01/22/02</u>	Signature of Inventor 3 <u>Chun-chieh Lee</u> Chun-Chieh Lee Date <u>01/22/02</u>
Signature of Inventor 4 <u>Sheng-Feng Hung</u> Sheng-Feng Hung Date <u>01/22/02</u>		